IPC ASSOCIATION CONNECT ELECTRONICS INDUSTR	© Copyright 2005. IPG	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					Materials and	Mfg Ir	formatio	n	
Supplier Infor	mation						·								
Company name* Compan			Company un	ompany unique ID U			Unique ID Authority					Response Date*			
nsemi											2024-05-21				
Contact Name		Title - Contact			I	Phone - Contact*				Ema	Email - Contact*				
Product-Env-Stev	wards	Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com				
uthorized Repre	esentative*	Title - Representative			I	Phone - Representative*				Emai	Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com			
Reques	ster Item Number Mfr Iter		em Number Mfr Item Name				Effective Dat	e Versio	on N	Manufacturing Site		Weig	Weight* UOM		Unit Type
		FDMC7672S PT7 NCF		PT7 NCH 30/20	7 NCH 30/20V Syncfet ML		2024-05-21 TH2		H2	21.0		76	mg	Each	
Ianufacturing	g Proccess Informati	on						,				<u>'</u>		•	·
Termina	al Plating / Grid Array Material		Terminal Base Alloy		J-STD-020 MS	ΓD-020 MSL Rating		Peak Process Body Temperature		Max Time at Peak Tempera		erature	ture Number of Reflow Cycles		eles
Preciou Sn)			CU Alloy		1		260		C	30	se	conds	3		
Comments															
vel 1 - maximum	ı time at peak temperatur	e during so	ldering is 10-3	30 seconds						· · · · · · · · · · · · · · · · · · ·					
or more informa	tion regarding material c	omposition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.05	mg	Supplier	Silicon (Si)	7440-21-3		1.05	mg
Die Attach	0.198	mg	Supplier	Silver (Ag)	7440-22-4		0.1584	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0396	mg
Lead Frame	7.664		Supplier	Zinc (Zn)	7440-66-6		0.01	mg
			Supplier	Iron (Fe)	7439-89-6		0.184	mg
			Supplier	Copper (Cu)	7440-50-8		7.47	mg
Mold Compound-Black	11.505	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		2.19	mg
			Supplier	Carbon Black (C)	1333-86-4		0.115	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		9.2	mg
Plating	0.198	mg	Supplier	Palladium (Pd)	7440-05-3		0.018	mg
			В	Nickel (Ni)	7440-02-0		0.178	mg
			Supplier	Gold (Au)	7440-57-5		0.002	mg
Wire Bond - Cu	0.461	mg	Supplier	Copper (Cu)	7440-50-8		0.461	mg